



1 KEY TOUCH PAD DETECTOR IC

GENERAL DESCRIPTION

The TTP223 is a touch pad detector IC which offers 1 touch key. The touching detection IC is designed for replacing traditional direct button key with diverse pad size. Low power consumption and wide operating voltage are the contact key features for DC or AC applications.

FEATURES

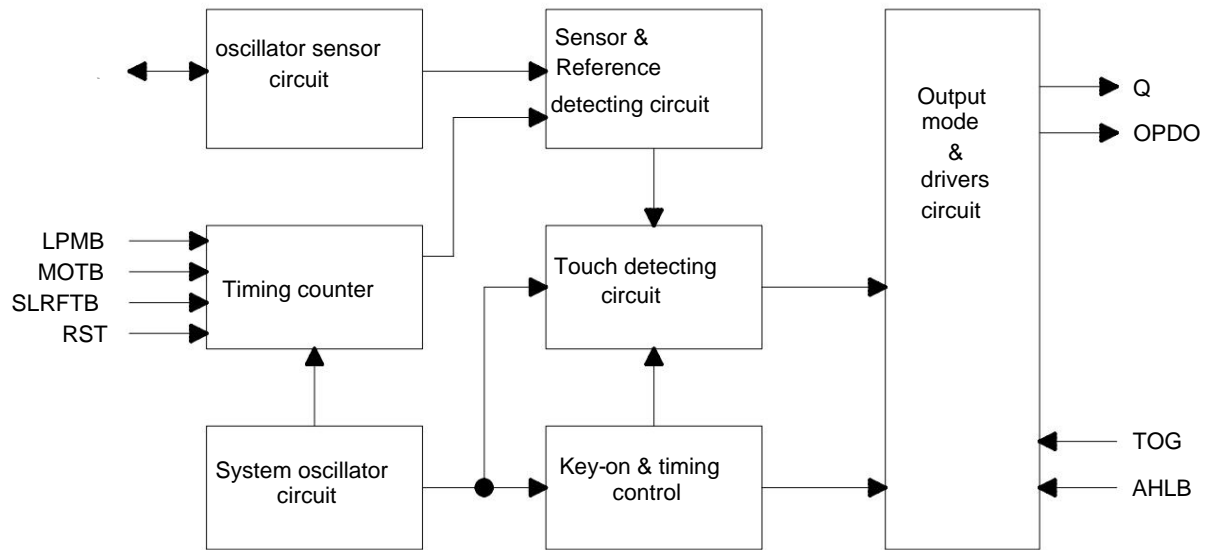
- Operating voltage 2.0V~5.5V
- Operating current @VDD=3V, no load, SLRFTB=1 At low power mode typical 1.5uA, maximum 3.0uA At fast mode typical 3.5uA, maximum 7.0uA @VDD=3V, no load, SLRFTB=0 At low power mode typical 2.0uA, maximum 4.0uA At fast mode typical 6.5uA, maximum 13.0uA The response time max about 60mS at fast mode, 220mS at low power mode @VDD=3V Sensitivity can adjust by the capacitance(0~50pF) outside Have two kinds of sampling length by pad option(SLRFTB pin)
- Stable touching detection of human body for replacing traditional direct switch key
- Provides Fast mode and Low Power mode selection by pad option(LPMB pin)
- Provides direct mode to toggle mode by pad option(TOG pin)
- Open drain mode by bonding option, OPDO pin is open drain output, Q pin is CMOS output All output modes can be selected active high or active low by pad option(AHLB pin)
- Have the maximum on time 100sec by pad option(MOTB pin)
- Have external power on reset pin(RST pin)
- After power-on have about 0.5sec stable-time, during the time do not touch the key pad, And the function is disabled
- Auto calibration for life
- And the re-calibration period is about 4.0sec, when key has not been touched

APPLICATION

- Wide consumer products
- Water proofed electrical products
- Button key replacement



BLOCK DIAGRAM



PAD DESCRIPTION

Pad No.	Pad Name	I/O	Type	Q	Pad Description
1			O	CMOS output pin	O Open
2	OPDO		drain output pin		Negative power
	VSS		supply, ground		P LPMB I-PH Low
3, 4	power mode selection,		1=>Fast mode; 0=>Low power		mode I-PL Output type option pin,
5	TOG		1=>Toggle mode; 0=>Direct mode		Positive power supply P AHLB I-PL
6	VDD		Output active high or low		
7	selection, 1=>Active low; 0=>Active high		I-PL External power on		reset pin SLRFTB I-PH Selecting
	RST		the sampling length, 1=>about 1.6msec;		
8, 9	0=>about 3.2msec 10		MOTB I-PH Maximum on time		100sec selection,
			1=>Disable, 0=>Enable		
eleven	Yo		I/O		Input sensor port

**ELECTRICAL CHARACTERISTICS****Absolute Maximum Ratings**

parameters	symbol	Conditions	Value	Unit
Operating Temperature	TOP		-20 ~ +70	°C
Storage Temperature	TSTG		-50 ~ +125	°C
Power Supply Voltage	VDD	Ta=25°C	VSS-0.3 ~ VSS+5.5	V
Input Voltage	VIN	Ta=25°C	VSS-0.3 ~ VDD+0.3	V
Note: VSS symbolizes for system ground				

DC/AC Characteristics(Test condition at room temperature=25°C)

parameters	symbol	Test Condition	Min.	Typ.	Max.	unit
Operating Voltage	VDD		2.0	3	5.5	V
System oscillator	FFAST	VDD=3V	-	512K	-	Hz
	FLOW			16K		
oscillator sensor	FSEN	VDD=3V no load	-	1M	-	Hz
Operating Current	IOP	VDD=3V at low power mode and output no load SLRFTB =1	-	1.5	3.0	uA
		VDD=3V at low power mode and output no load SLRFTB =0	-	2.0	4.0	
		VDD=3V at fast mode =1 and output no load SLRFTB	-	3.5	7.0	
		VDD=3V at fast mode =1 and output no load SLRFTB	-	6.5	13.0	
Input Ports	VIL Input	Low Voltage HIV	0	-	0.2 VDD	
Input Ports	Input High Voltage	IOL VDD=3V,	0.8	-	1.0 VDD	
Output Port Sink Current	VOL=0.6V IOH	VDD=3V,	-	8	- mA	
Output Port Source Current	VOH=2.4V	VDD=3V, At fast mode	-	-4	- mA	
Output Response Time	mode	TR VDD=3V, At low power			60	ms
					220	
Input Pin Pull-high Resistor RPH	VDD=3V,	(LPMB, MOTB, SLRFTB)		35K		ohm
Input Pin Pull-low Resistor RPL		VDD=3V, (TOG, AHLB)		28K		ohm
		VDD=3V, (RST)		200K		



FUNCTION DESCRIPTION

1. Sensitivity adjustment

The total loading of electrode size and capacitance of connecting line on PCB can affect the sensitivity. So the sensitivity adjustment must according to the practical application on PCB. The TTP223 offers some methods for adjusting the sensitivity outside.

1-1 by the electrode size

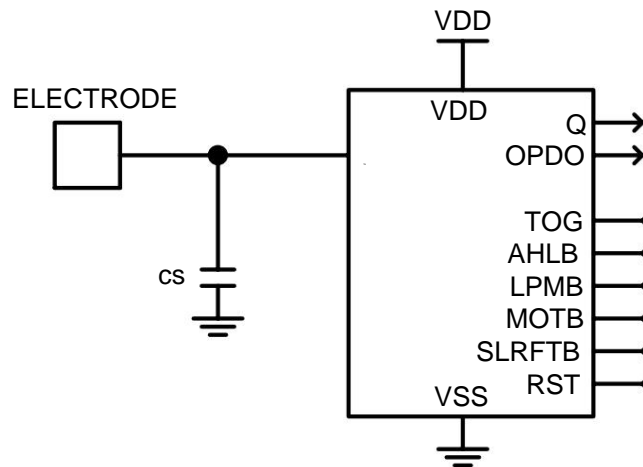
Under other conditions are fixed. Using a larger electrode size can increase sensitivity. Otherwise it can decrease sensitivity. But the electrode size must be used in the effective scope. 1-2 by the panel

thickness Under other conditions are fixed. Using a thinner panel can increase sensitivity.

Otherwise it can decrease sensitivity. But the panel thickness must be below the maximum value. 1-3 by the value of Cs (please see the down figure)

Under other conditions are fixed. When do not use the Cs to VSS, the sensitivity is most sensitive.

When adding the values of Cs will reduce sensitivity in the useful range (0~Cs~50pF).



2. Output mode

The TTP223 has direct mode active high or low by AHLB pad option. And has toggle mode by TOG pad option. Another has open drain mode by bonding option. Pad Q is digital output, pad OPDO is open drain output.

TOG	AHLB Pad	Q option features	Pad OPDO option features
0	0	direct mode, CMOS active high output	direct mode, Open drain active high output
0	1	direct mode, CMOS active low output	direct mode, Open drain active low output
1	0	toggle mode, Power on state=0	toggle mode, Power on state high-Z, Active high
1	1	toggle mode, Power on state=1	toggle mode, Power on state high-Z, Active low



3. Maximum key on duration time (By MOTB pad option)

If some objects cover in the sense pad, and causing the change quantity enough to be detected. To prevent this, the TTP223 sets a timer to monitor the detection. The timer is the maximum on duration time. It is set about 100sec at 3V. When the detection is over the timer, the system will return to the initial power-on state, and the output becomes inactive until the next detection.

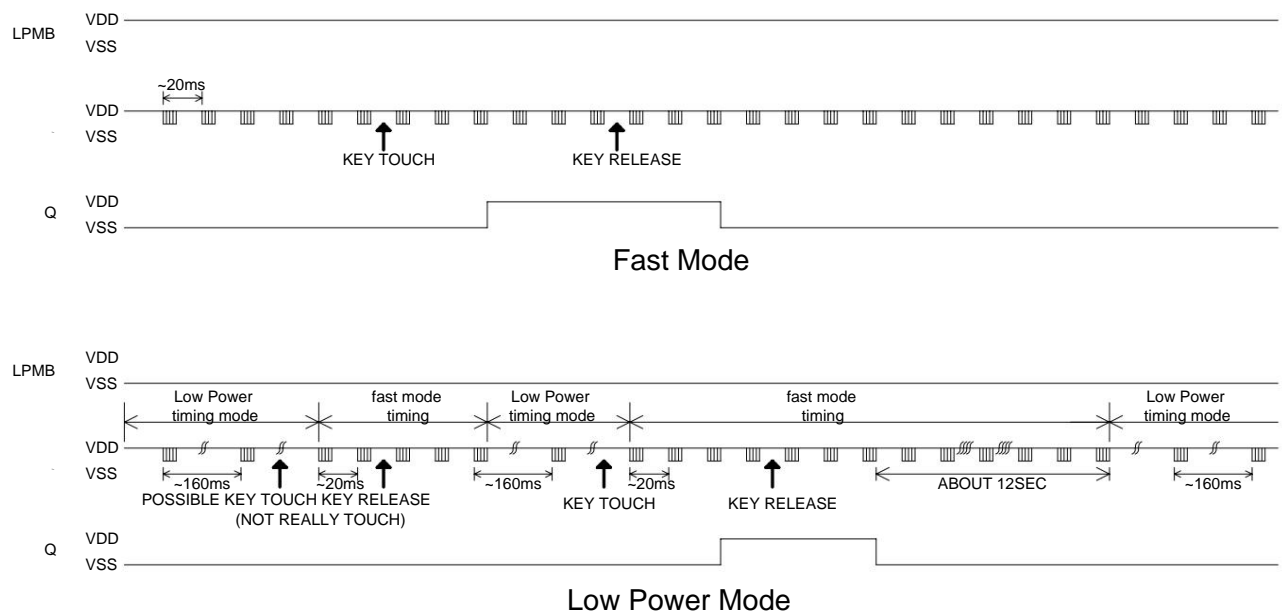
MOTB Option features	1 Infinite(Disable maximum on time)	0 Maximum on time 100sec

4. Fast and Low power mode selection (By LPMB pad option)

The TTP223 has Fast mode and Low Power mode to be selected. It depends on the state of LPMB pad. When the LPMB pin is opened or connected to VDD, the TTP223 runs in Fast mode. When the LPMB pin is connected to VSS, the TTP223 runs in Low Power mode.

In the Fast mode response time is faster, but the current consumption will be increased. In the Low Power mode it will be saving power, but it will be slowing response time for first touch. When it awakens in fast mode, the response time is the same as the fast mode. In this mode when detecting key touch, it will switch to Fast mode. Until the key touch is released and it will keep a time about 12sec. Then it returns to Low Power mode.

The states and timing of two modes please see below figure.



LPMB	Option features
1	fast mode
0	Low Power mode

5. Sampling length selection (By SLRFTB pad option)

The TTP223 has two kinds of sampling lengths to be selected. It depends on the state of SLRFTB pad. When the SLRFTB pin is opened or connected to VDD, the sampling length is about 1.6msec. When the SLRFTB pin is connected to VSS, the sampling length is about 3.2msec.

When selecting 3.2msec sampling length the sensitivity will be better, but the current consumption will be increased. Recommend to use 1.6msec sampling length.

SLRFTB	Option features
1	Sampling length = 1.6msec
0	Sampling length = 3.2msec

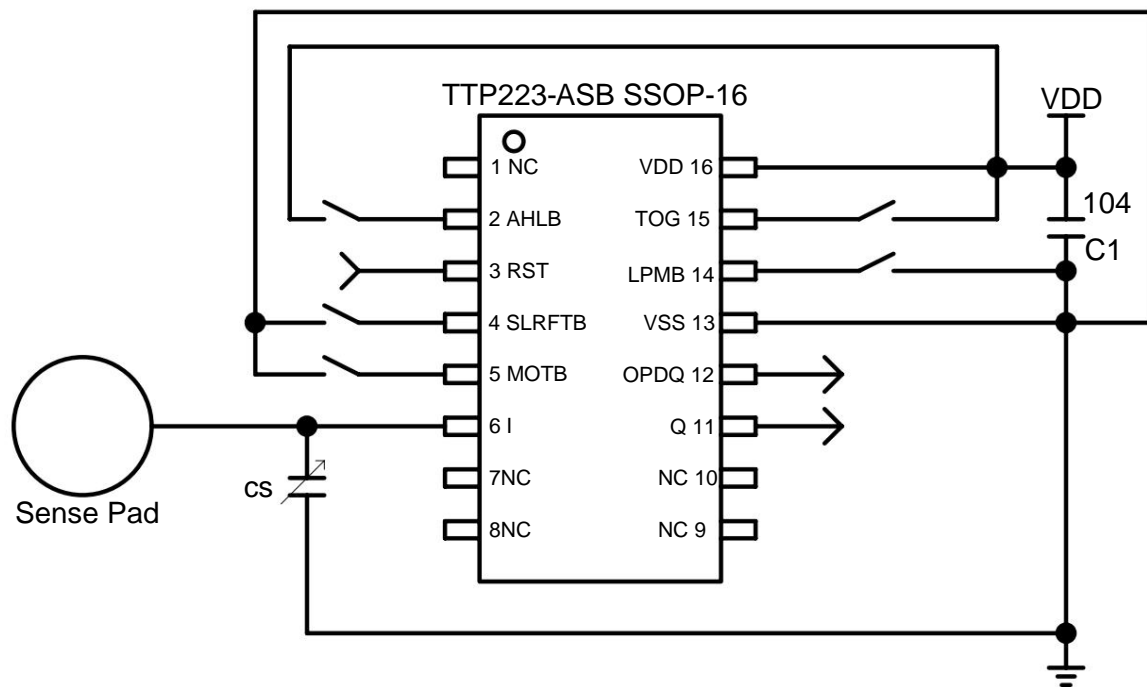
**6. Option pin**

For power saving concern and package bonding option consideration, all the feature option pins with latch type design and initial states are 0 or 1 as power on. If those pins are forced to VDD or VSS, the states will be changed to 1 or 0 without any current leakage to conflict the power saving issue.

Feature option pins	Initial state by Power on 0 0
AHLB	
TOG	
LPMB	
MOTB	
SLRFTB	1 1 1



APPLICATION CIRCUIT



PSÿ1. On PCB, the length of lines from touch pad to IC pin shorter is better.

And the lines do not parallel and cross with other lines.

2. The power supply must be stable. If the supply voltage drift or shift quickly, maybe causing sensitivity anomalies or false detections.
3. The material of panel covering on the PCB can not include the metal or the electric element. The paints on the surfaces are the same.
4. The capacitance Cs can be used to adjust the sensitivity. The value of Cs use smaller, then the sensitivity will be better. The sensitivity adjustment must according to the practical application on PCB. The range of Cs value is 0~50pF.



Preliminary

TTP223

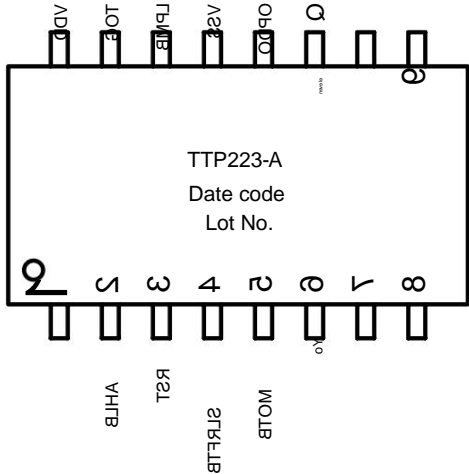
PACKAGE LIST

1. TTP223-ASB

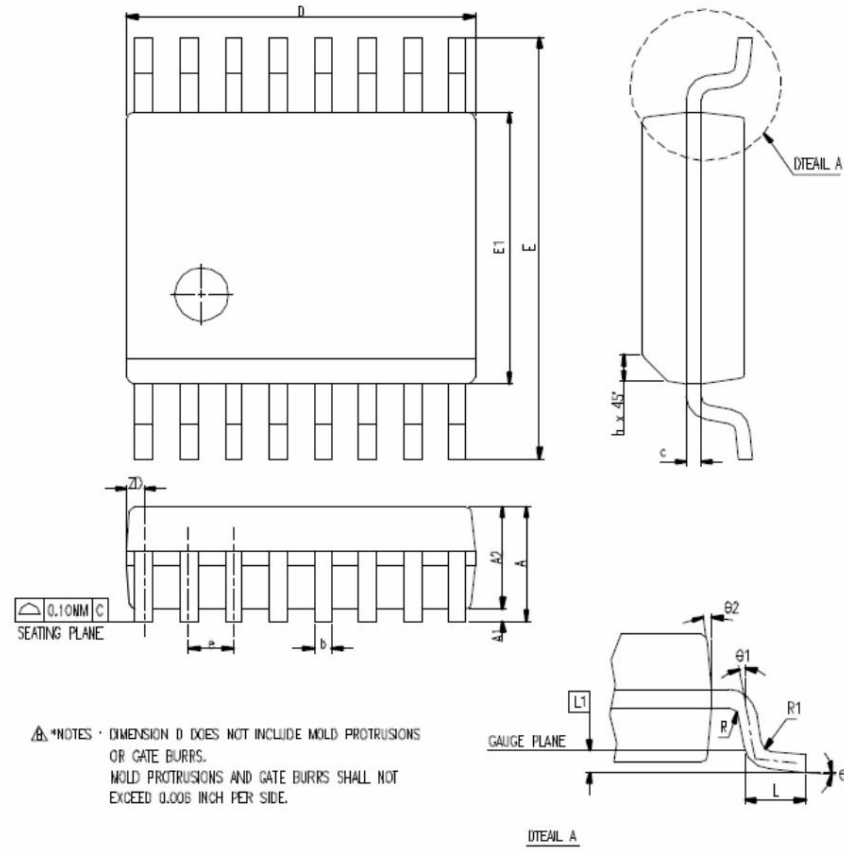
Package Item	Package Type	Option Features							
		AHLB	TOG	LPMB	MOTB	SLRFTB	RST	Q	OPDO
TTP223-ASB	SSOP-16	VVVVVVVV							

PS: The mark of √V√V express that package item has the option feature pin.

TTP223-ASB PACKAGE CONFIGURATION



Package Outline Dimension



SYMBOL	DIMENSION IN MM			DIMENSION IN INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	1.35	1.63	1.75	0.053	0.064	0.069
A1	0.10	0.15	0.25	0.004	0.006	0.010
A2			1.50			0.059
b	0.20		0.30	0.008		0.012
c	0.18		0.25	0.007		0.010
e	0.635 BASIC			0.025 BASIC		
D	4.80	4.90	5.00	0.189	0.193	0.197
E	5.79	5.99	6.20	0.228	0.236	0.244
E1	3.81	3.91	3.99	0.150	0.154	0.157
L	0.41	0.635	1.27	0.016	0.025	0.050
h	0.25		0.50	0.010		0.020
L1	0.254 BASIC			0.010 BASIC		
ZD	0.229 REF			0.009 REF		
R1	0.20		0.33	0.008		0.013
R	0.20			0.008		
θ	0°		8°	0°		8°
θ1	0°			0°		
θ2	5°	10°	15°	5°	10°	15°
JEDEC	MO-137 (AB)					

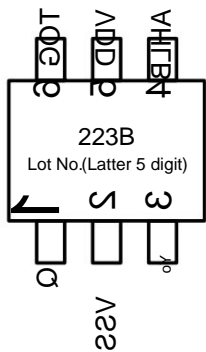


2. TTP223-BA6

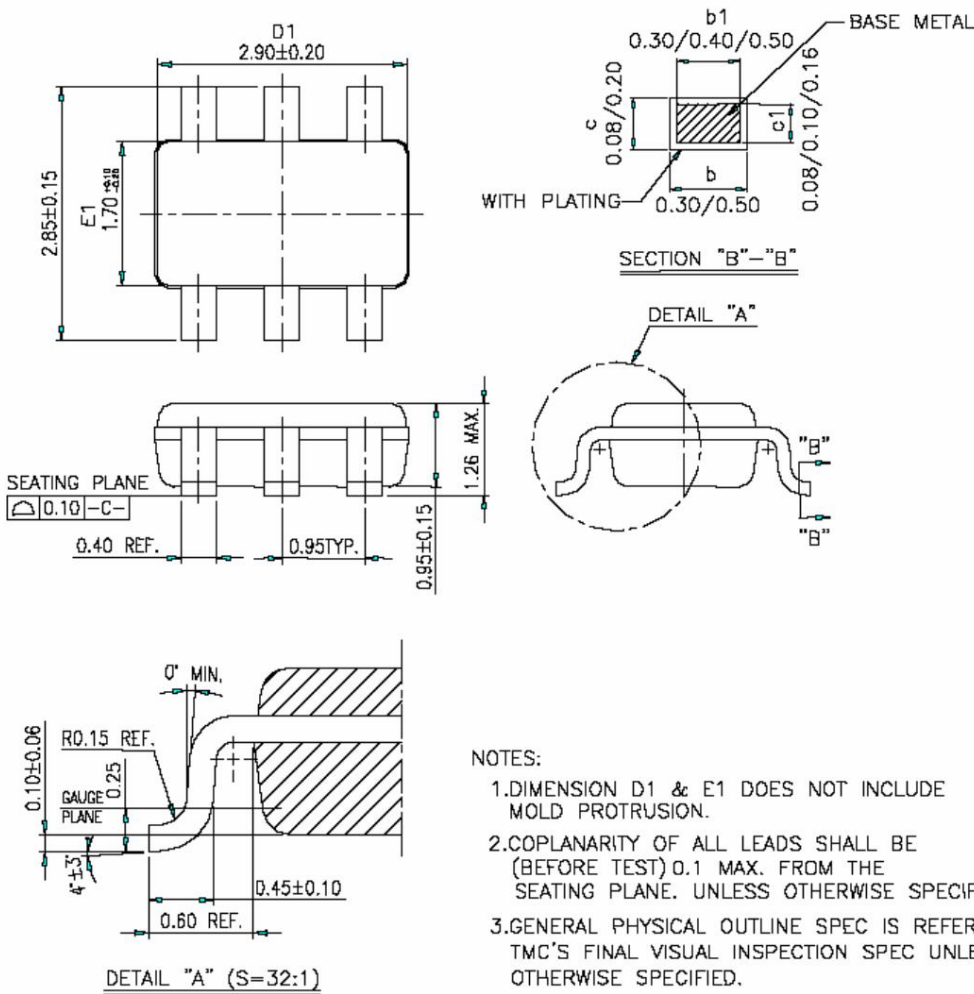
Package Item	Package Type	Option Features							
		AHLB	TOG	LPMB	MOTB	SLRFTB	RST	Q	OPDO
TTP223-BA6	SOT-23-6L	VV	0			1	1	XVX	

- PS: The mark of $\ddot{V}\ddot{V}$ express that package item has the option feature pin.
- The mark of $\ddot{Y}\ddot{X}$ express that package item has no the option feature pin.
- The mark of $\ddot{Y}0$ \ddot{Y} express that the state of option pin is fixed to VSS in the package item.
- The mark of $\ddot{Y}1$ \ddot{Y} express that the state of option pin is fixed to VDD in the package item.

TTP223-BA6 PACKAGE CONFIGURATION



Package Outline Dimension



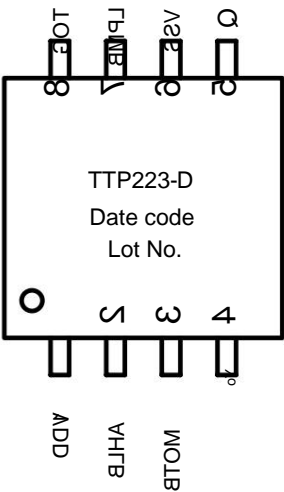


3. TTP223-DO8

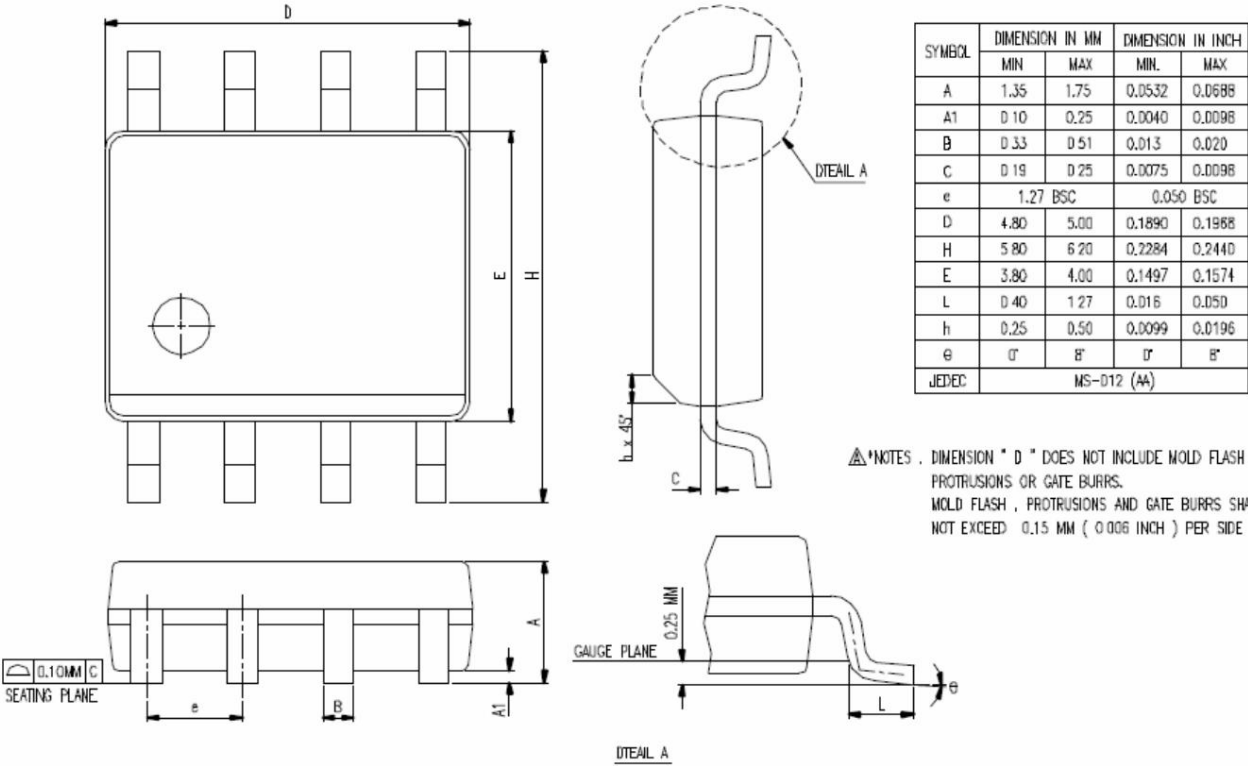
Package Item	Package Type	Option Features							
		AHLB	TOG	LPMB	MOTB	SLRFTB	RST	Q	OPDO
TTP223-DO8	SOP-8	VVVV				1	XVX		

- PS: The mark of $\ddot{y}\ddot{V}\ddot{y}$ express that package item has the option feature pin.
- The mark of $\ddot{y}X\ddot{y}$ express that package item has no the option feature pin.
- The mark of $\ddot{y}0\ddot{y}$ express that the state of option pin is fixed to VSS in the package item.
- The mark of $\ddot{y}1\ddot{y}$ express that the state of option pin is fixed to VDD in the package item.

TTP223-DO8 PACKAGE CONFIGURATION



Package Outline Dimension





ORDER INFORMATION a.

Package form: TTP223-XXX b.

Chip form: TCP223 c.

Base wafer: TDP223

REVIEW HISTORY 1.

2008/04/07

-Original version V_1.0